

FIG. 1

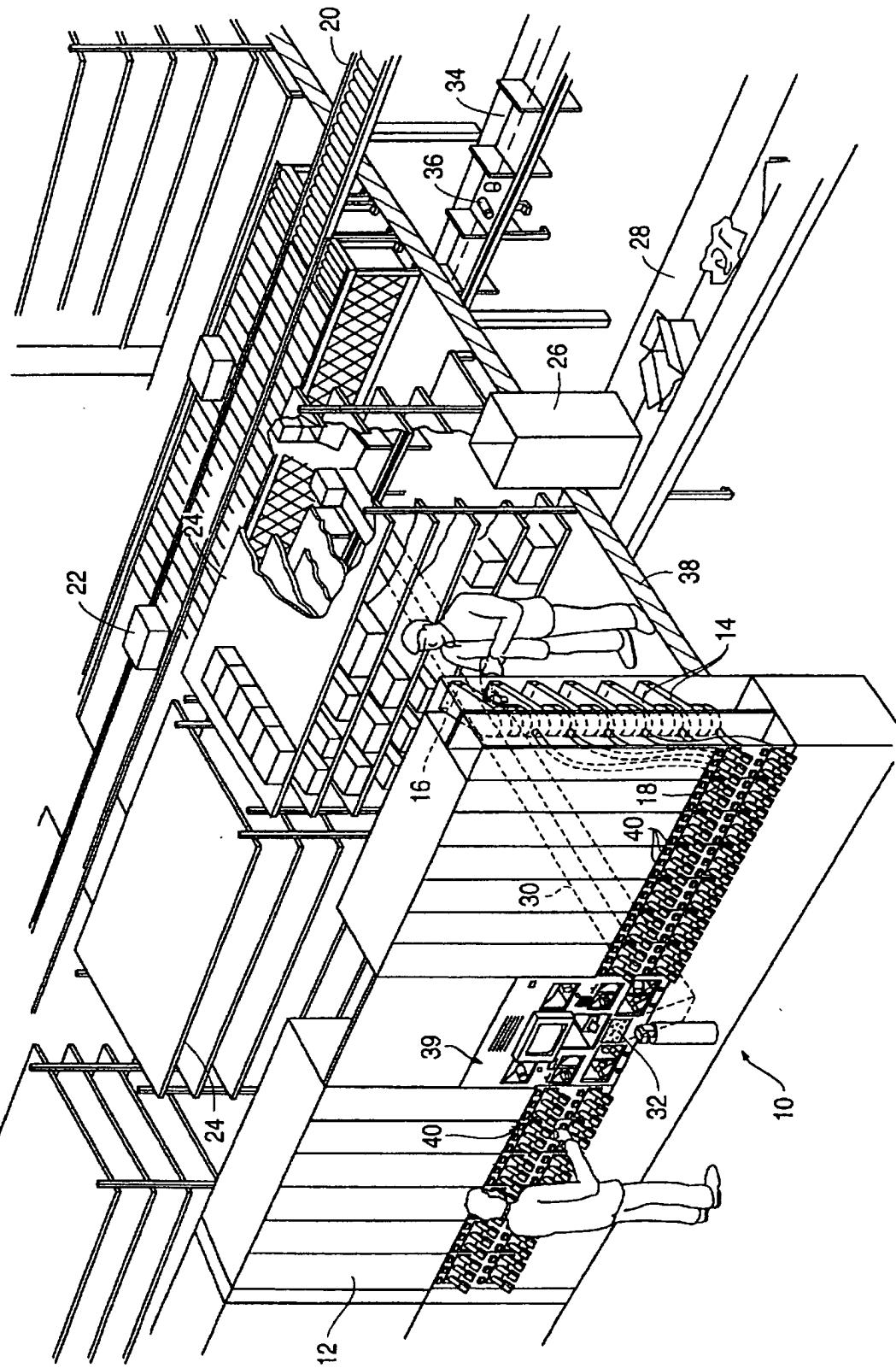


FIG. 2

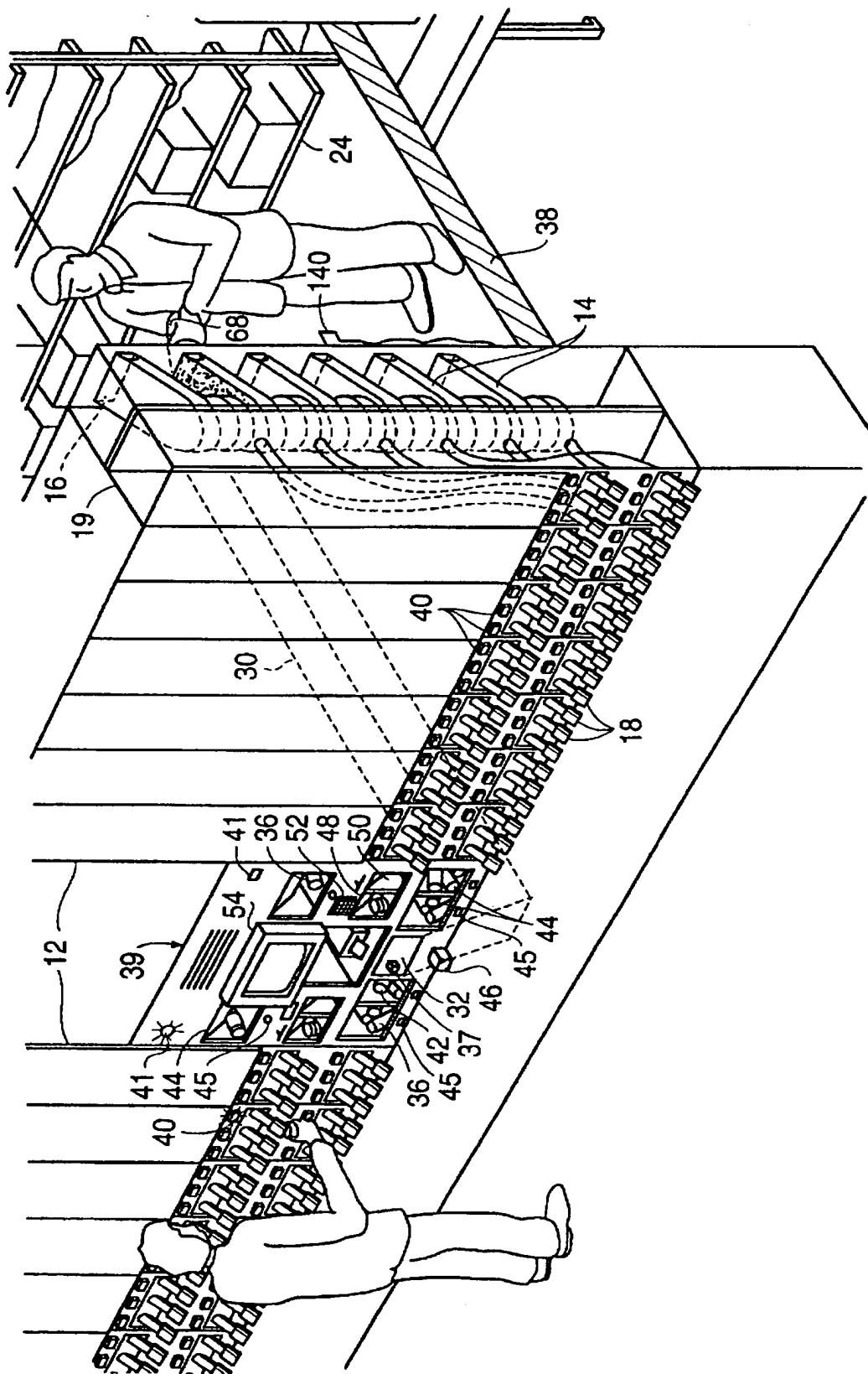


FIG. 3

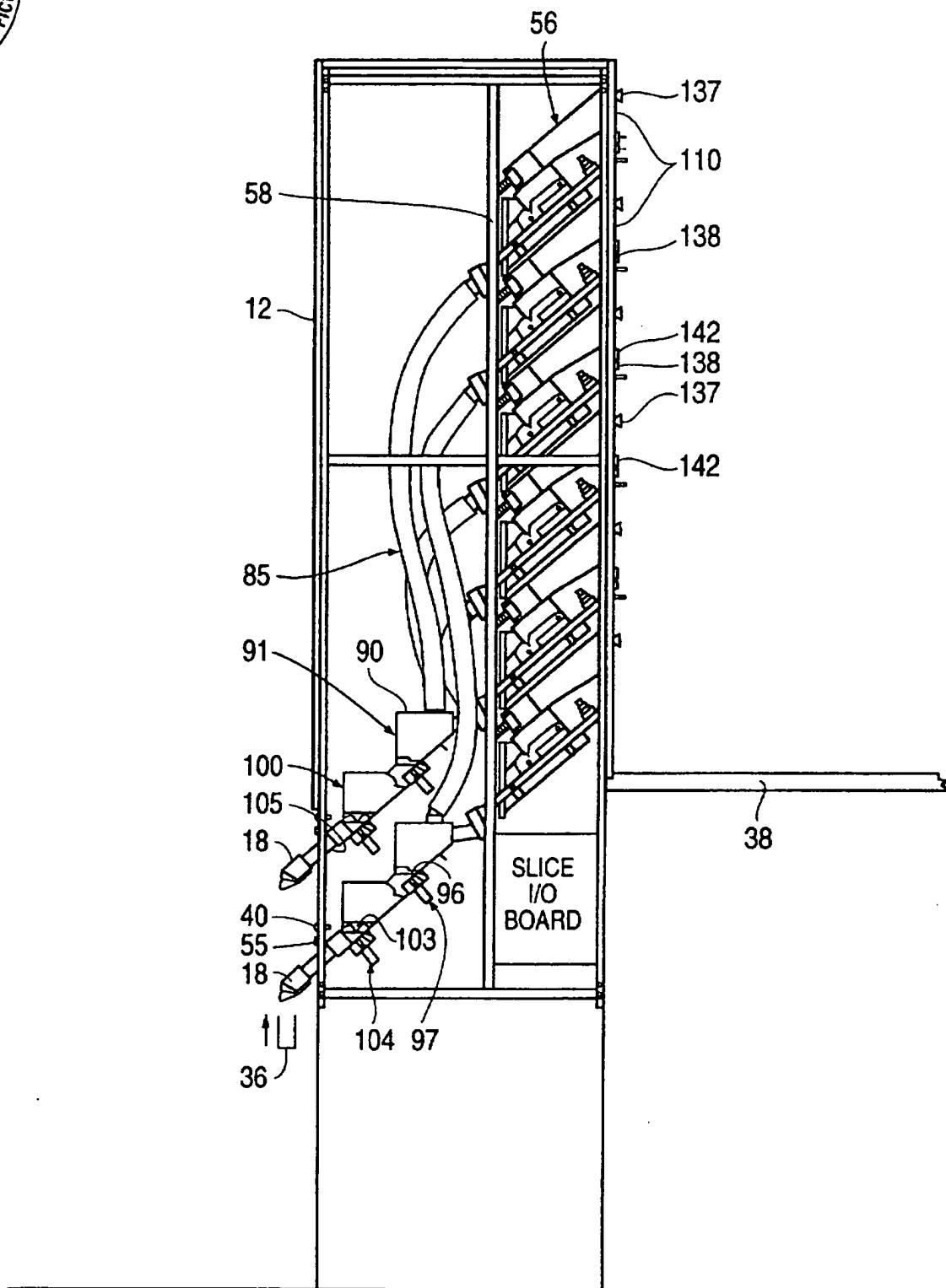




FIG. 4

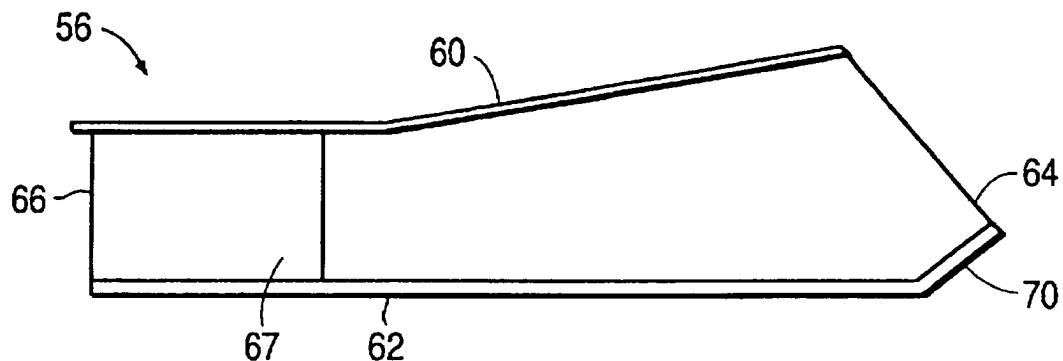


FIG. 5

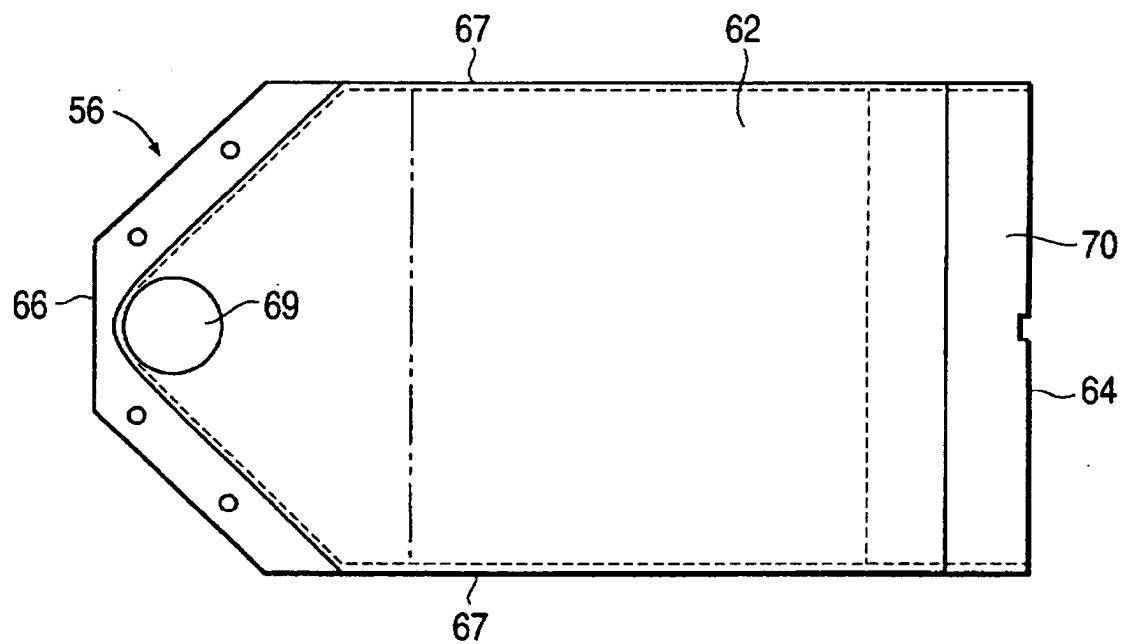


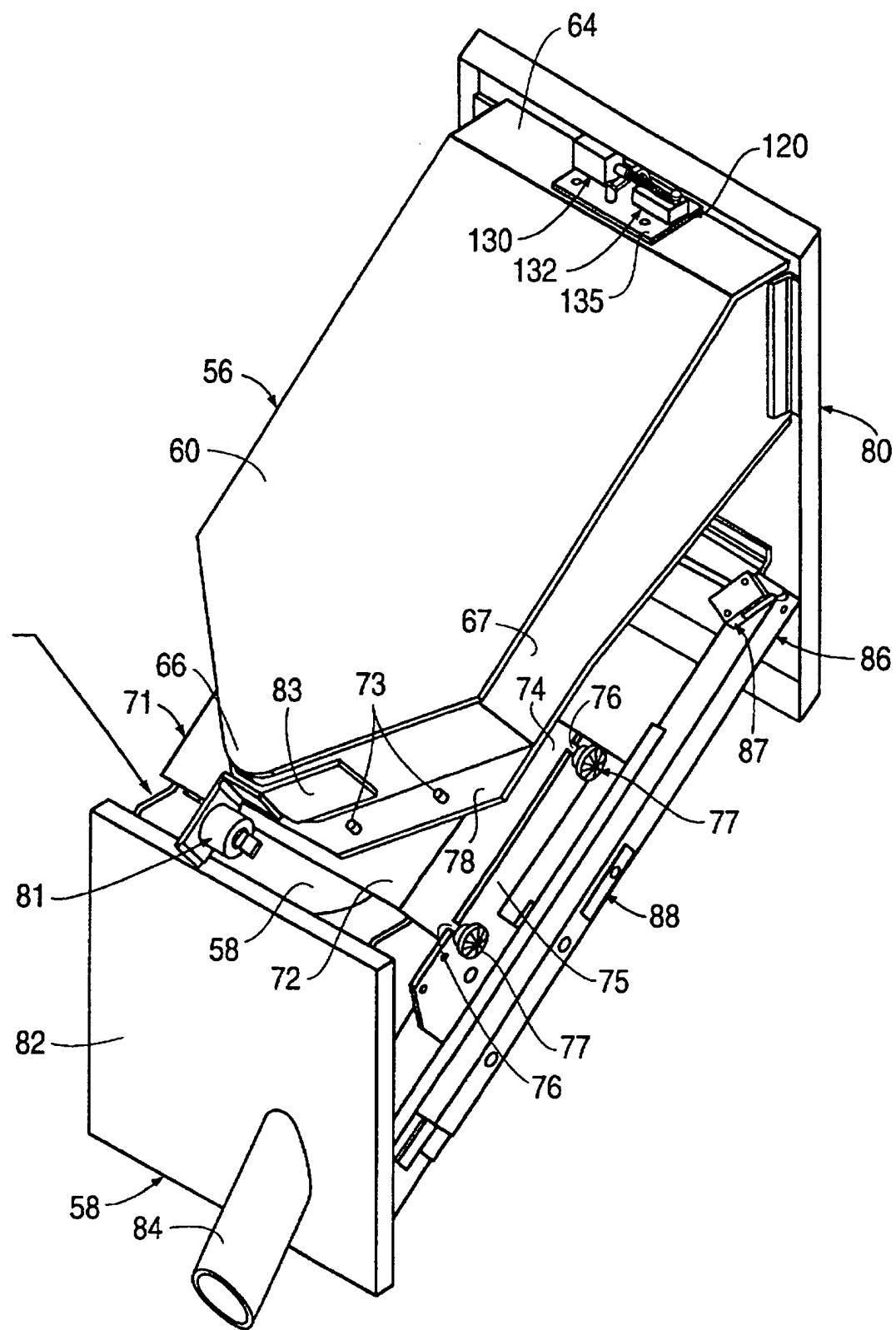
FIG. 6

FIG. 7

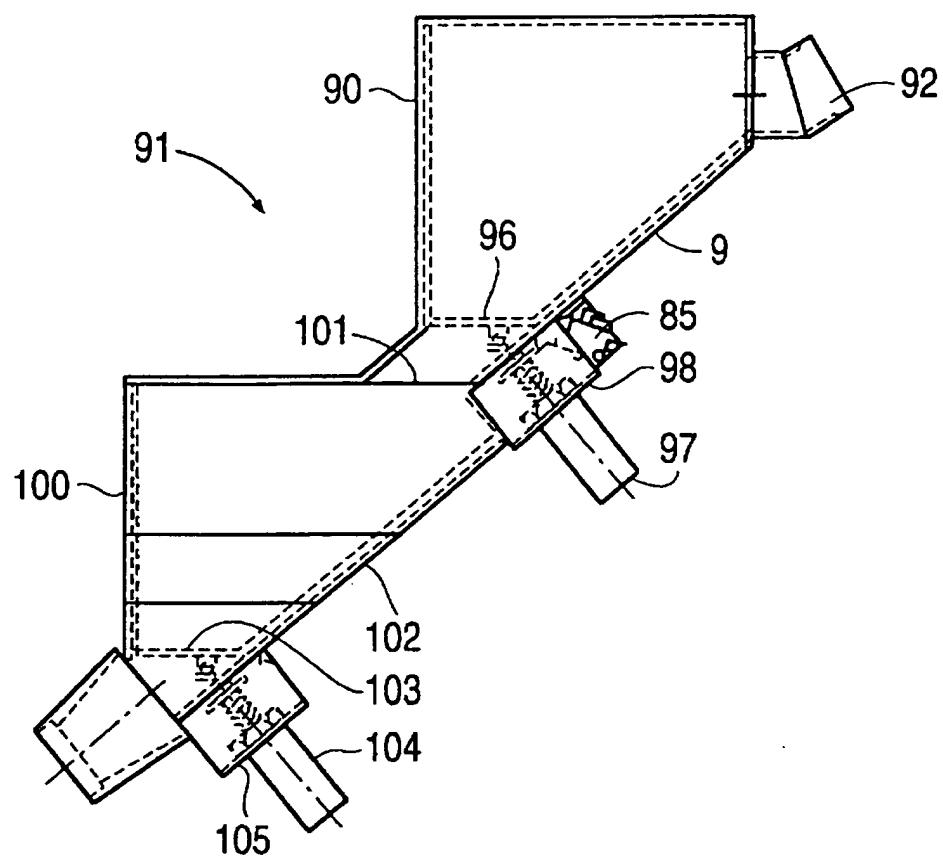
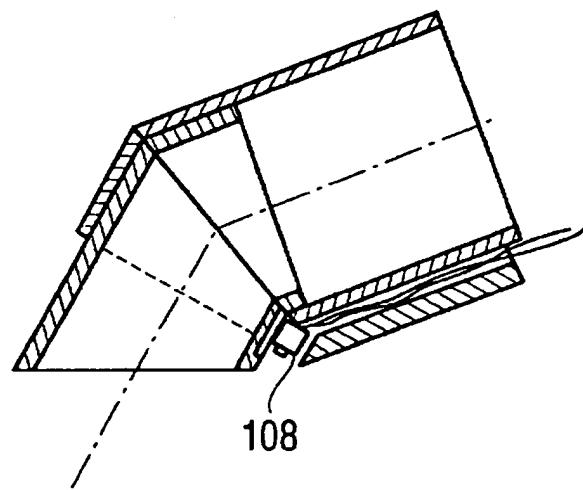


FIG. 8



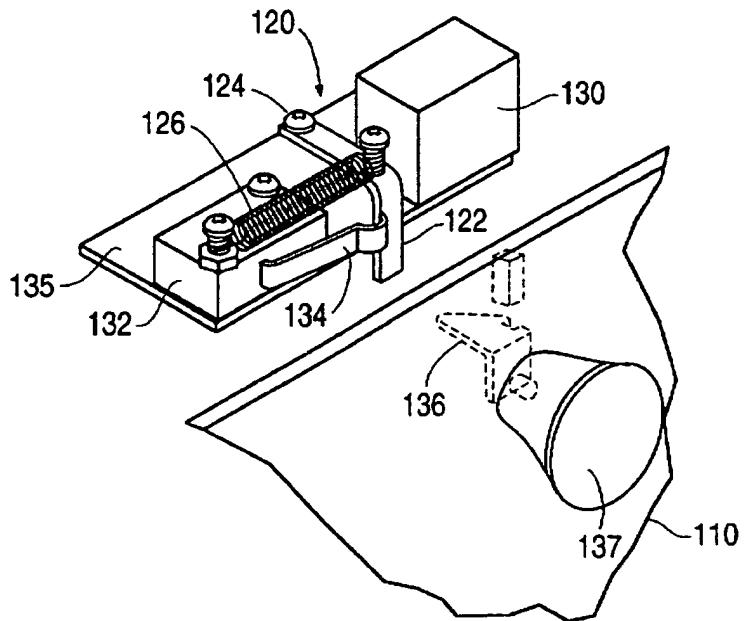
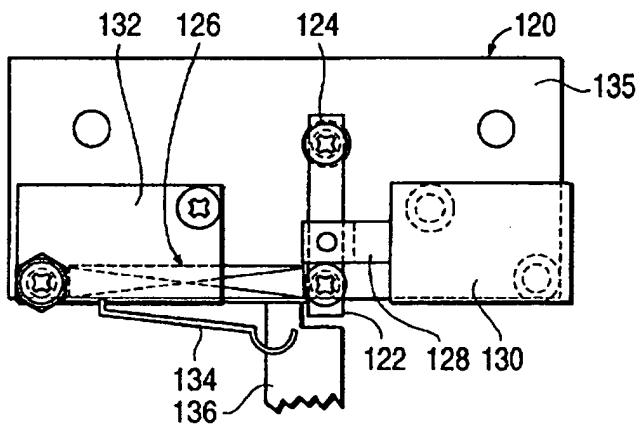
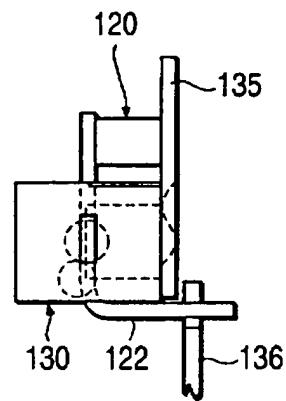
***FIG. 9******FIG. 10******FIG. 11***

FIG. 12

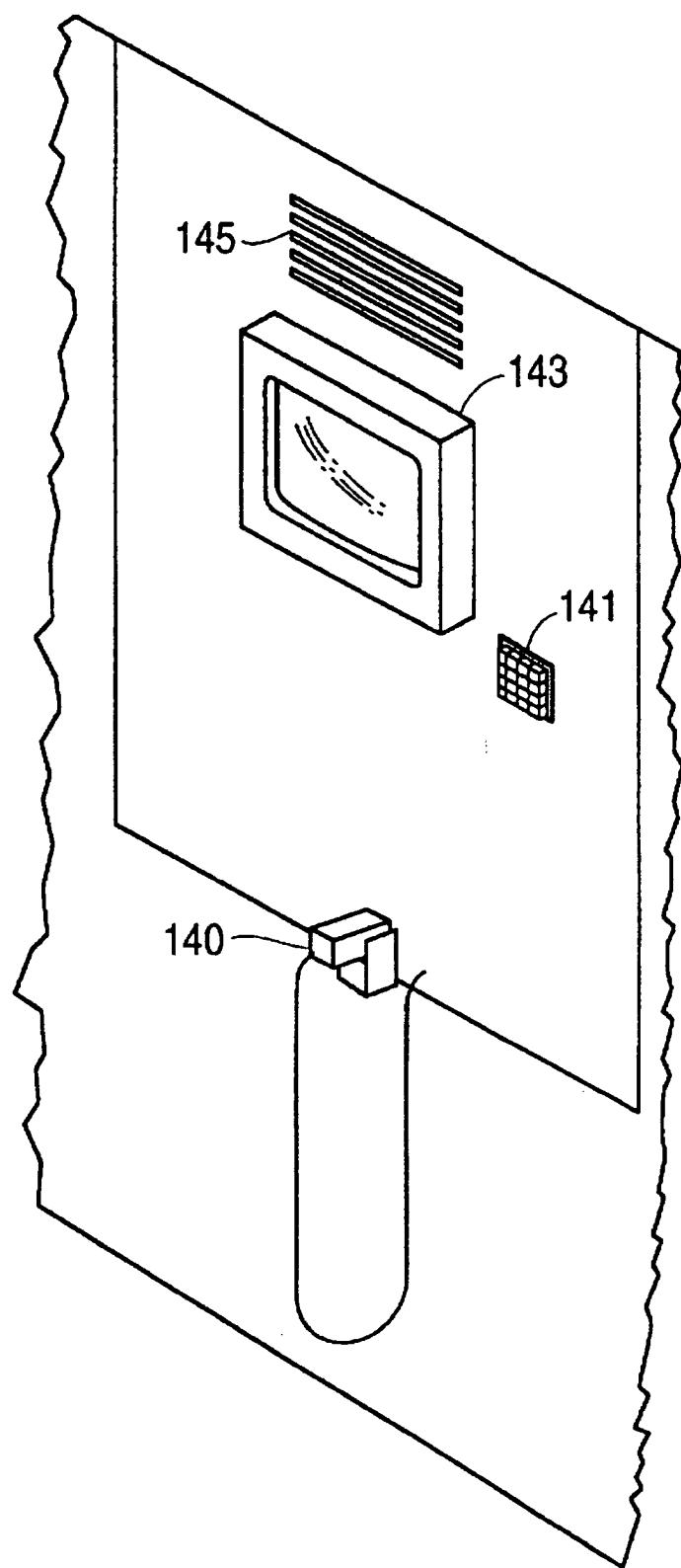




FIG. 13

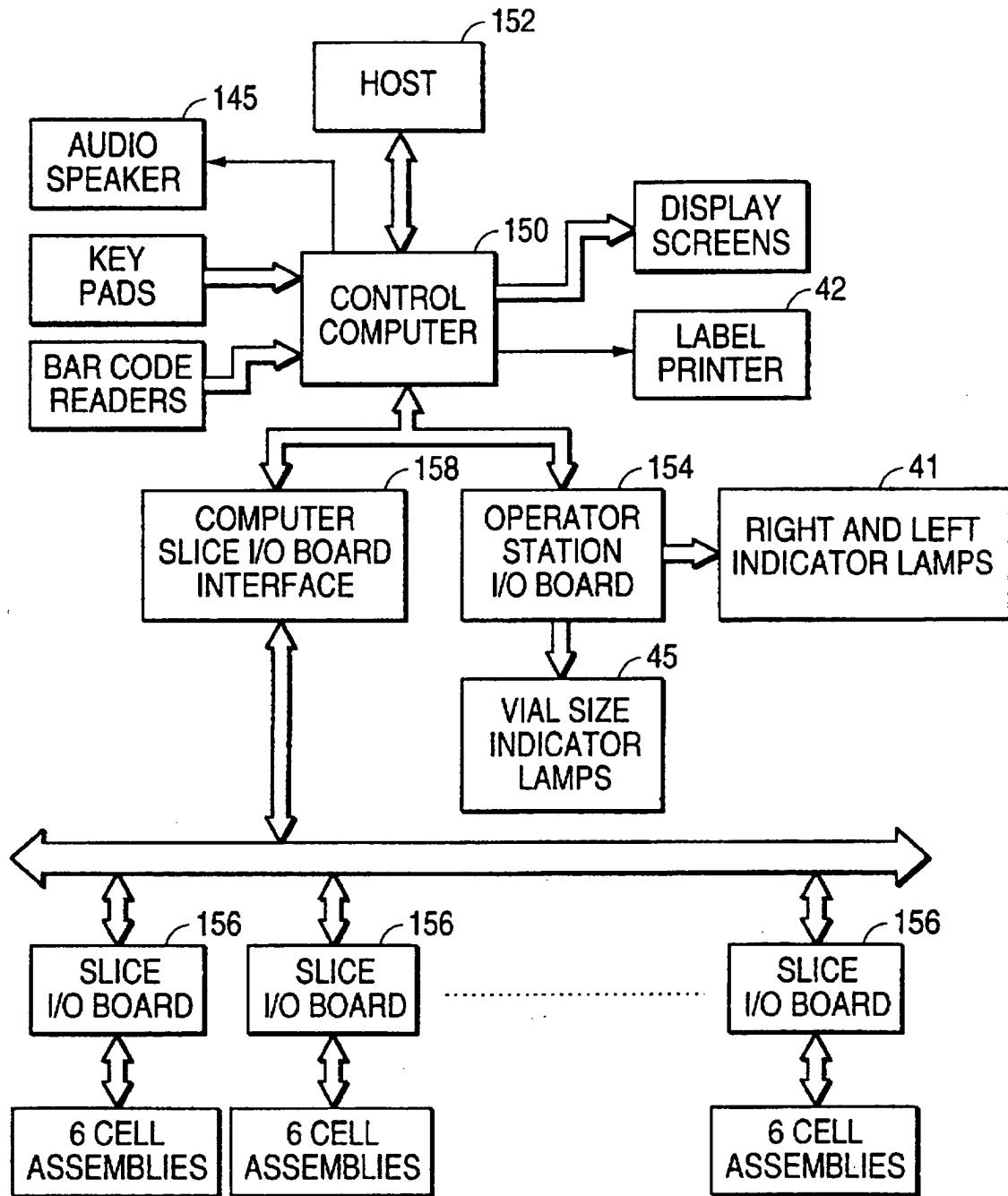


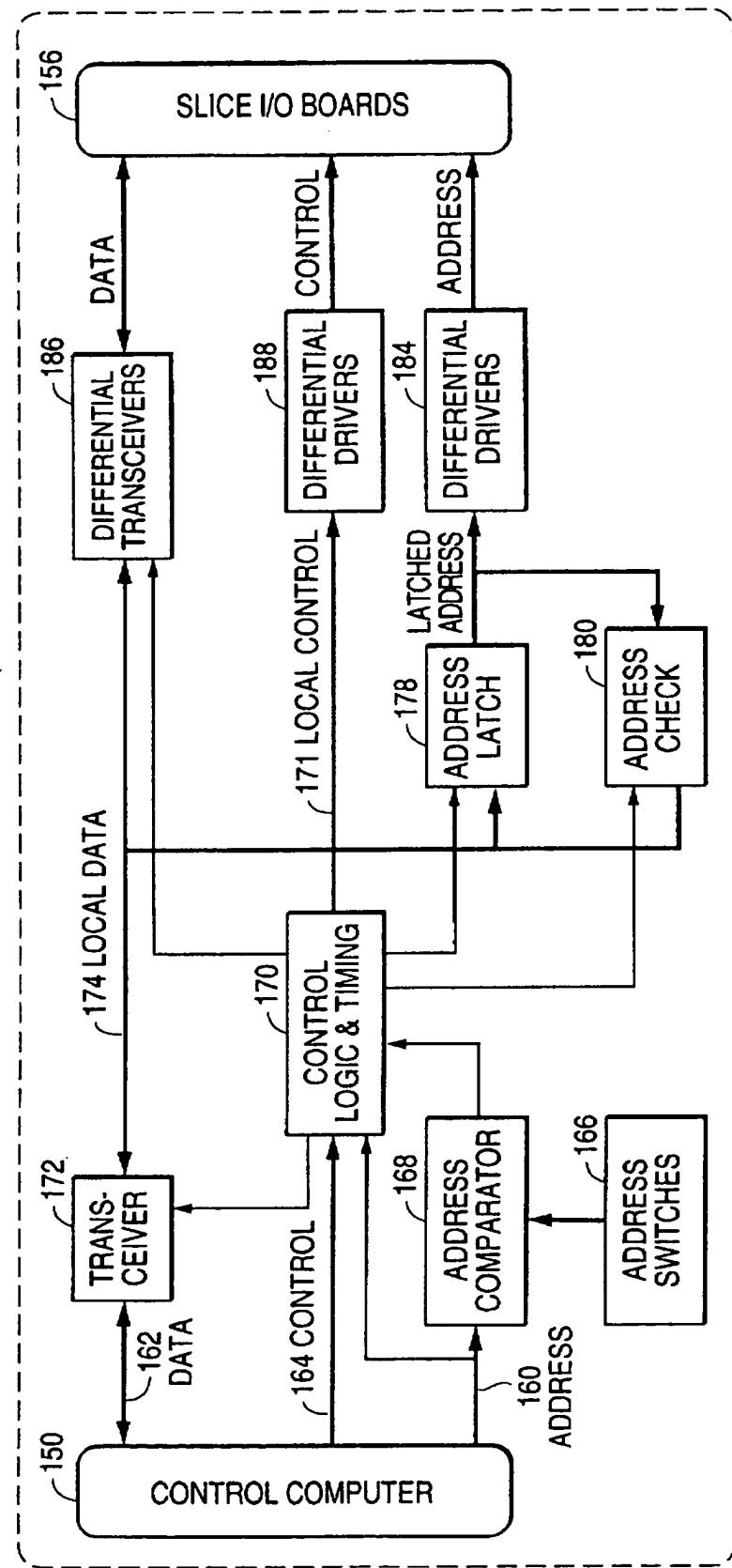
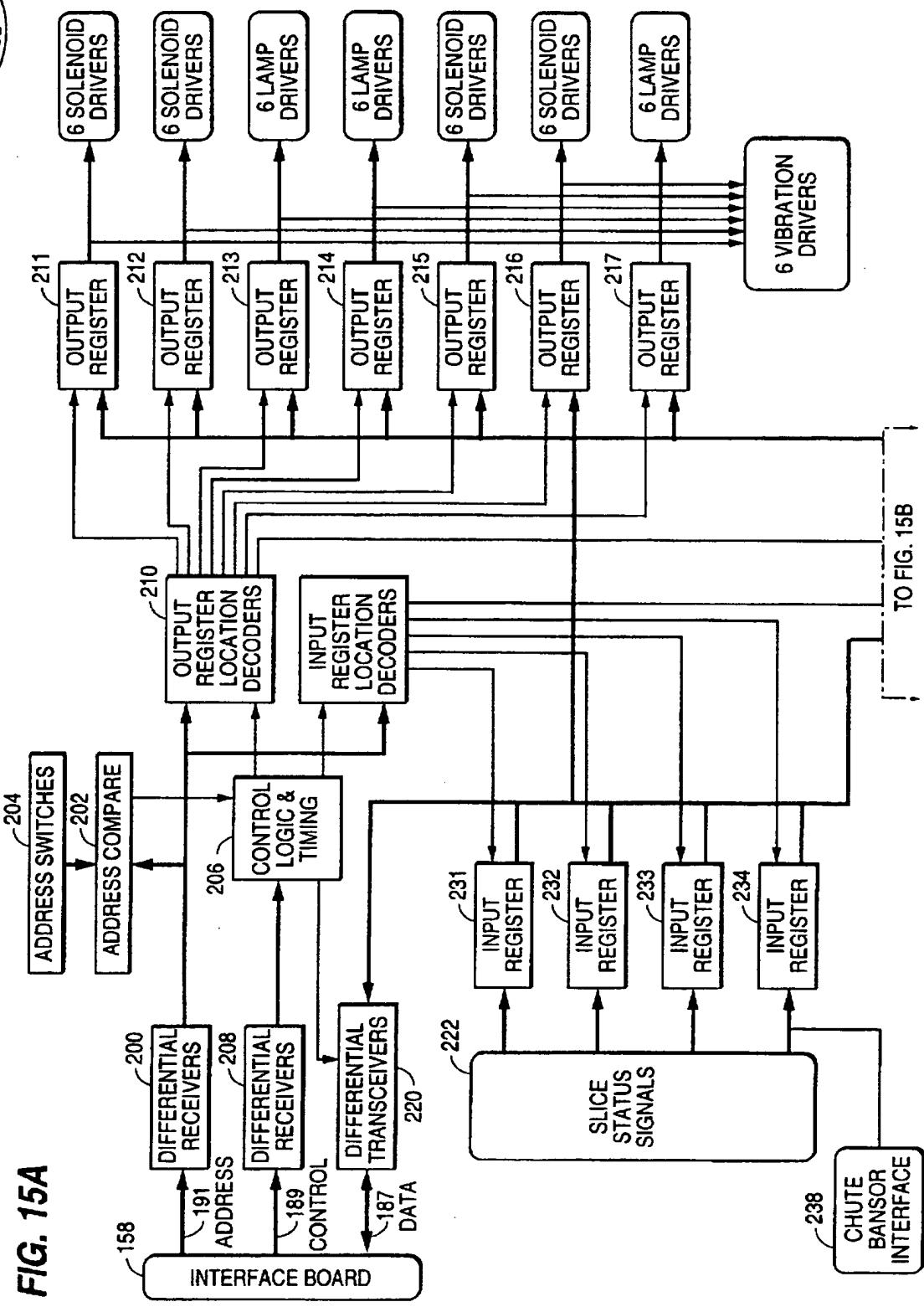
FIG. 14

FIG. 15A



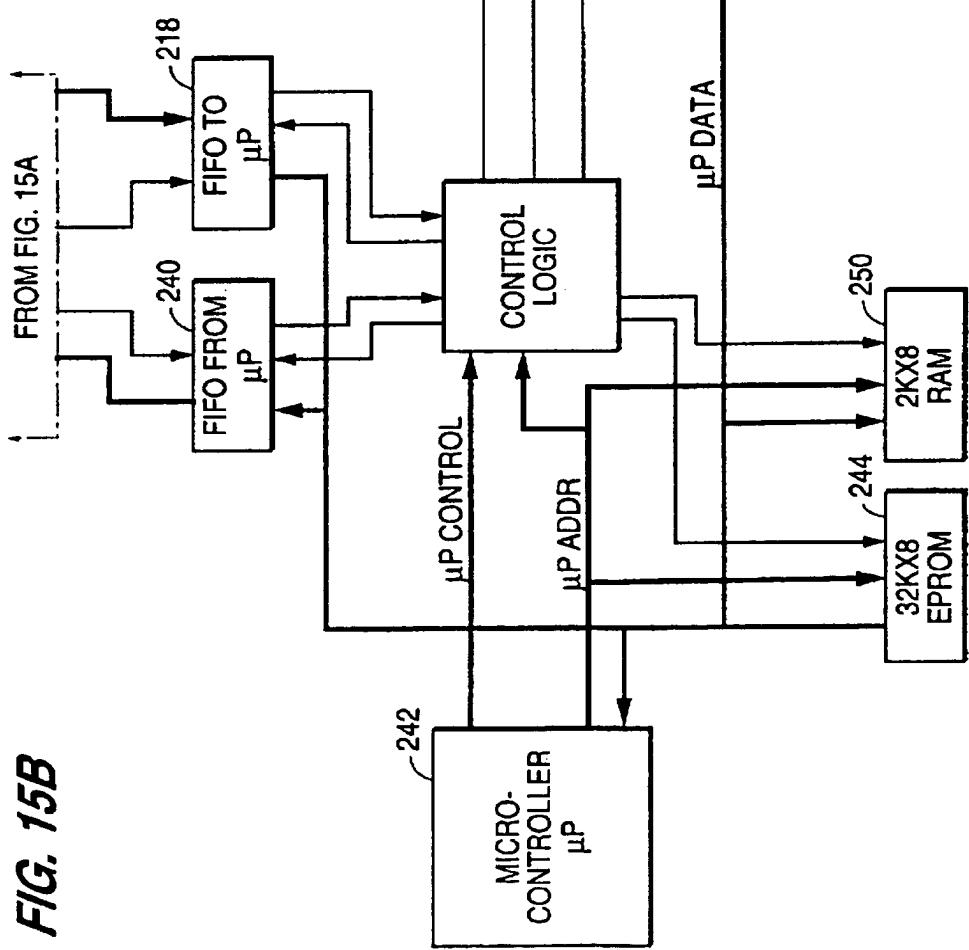


FIG. 16

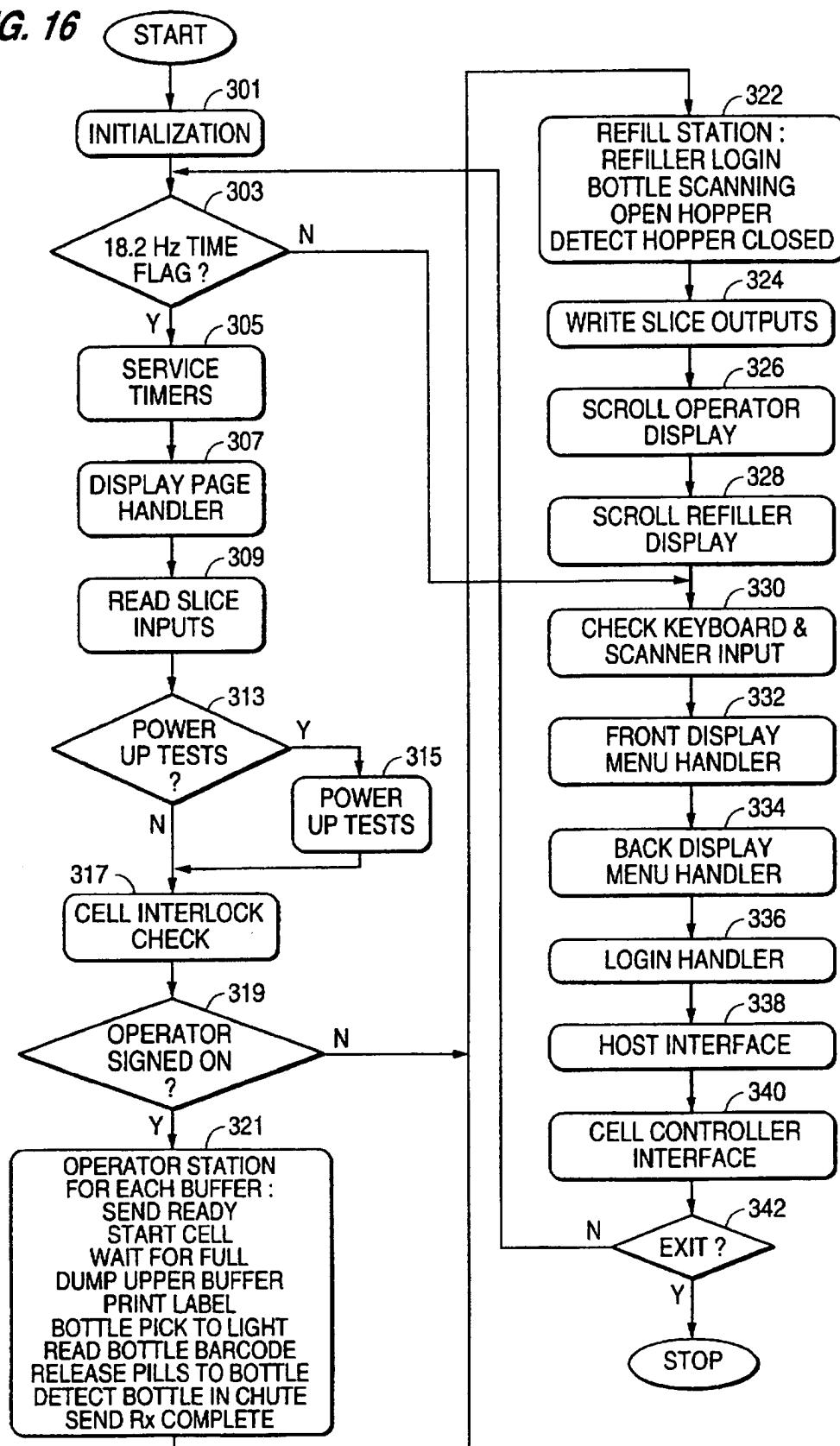




FIG. 17A

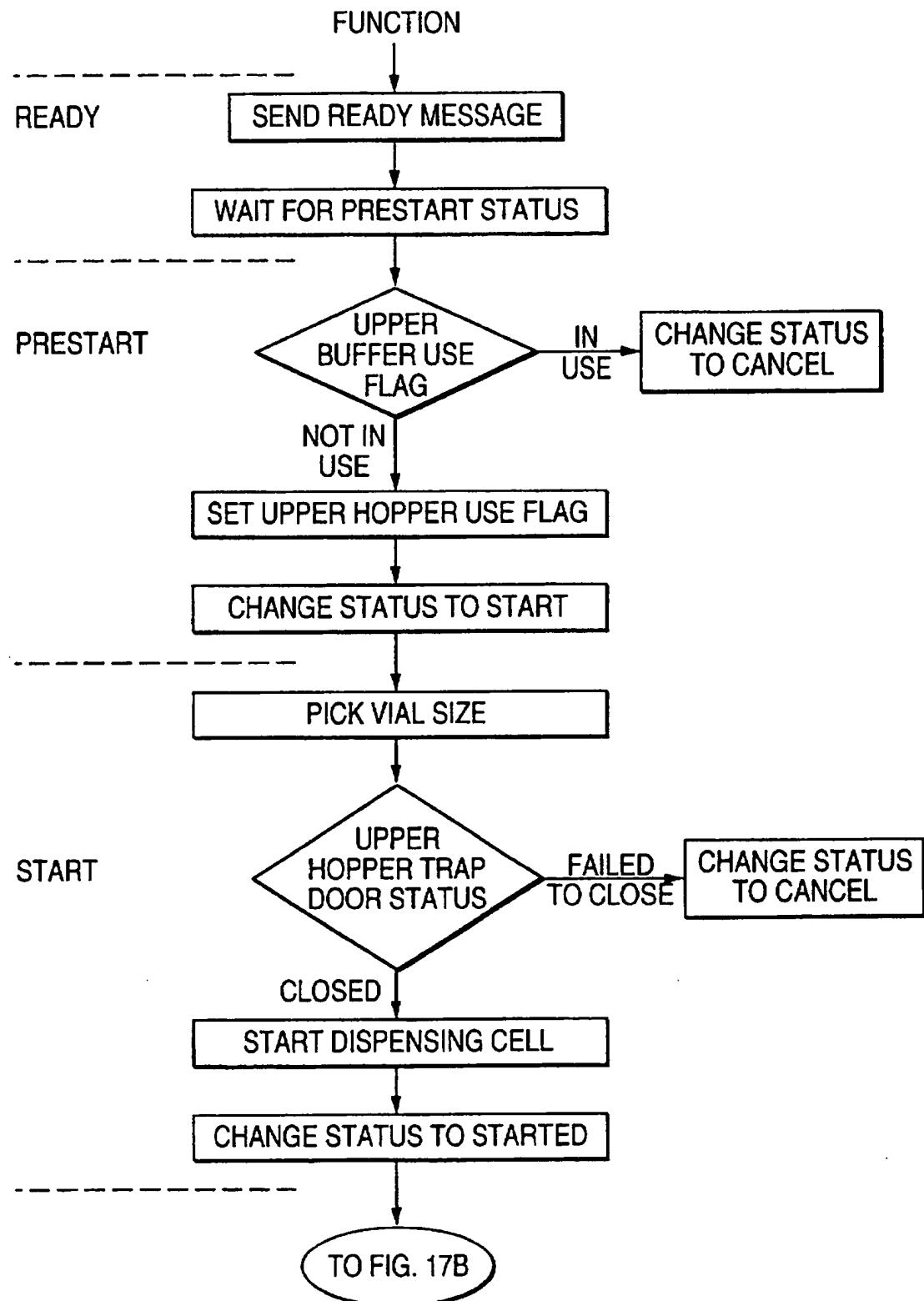


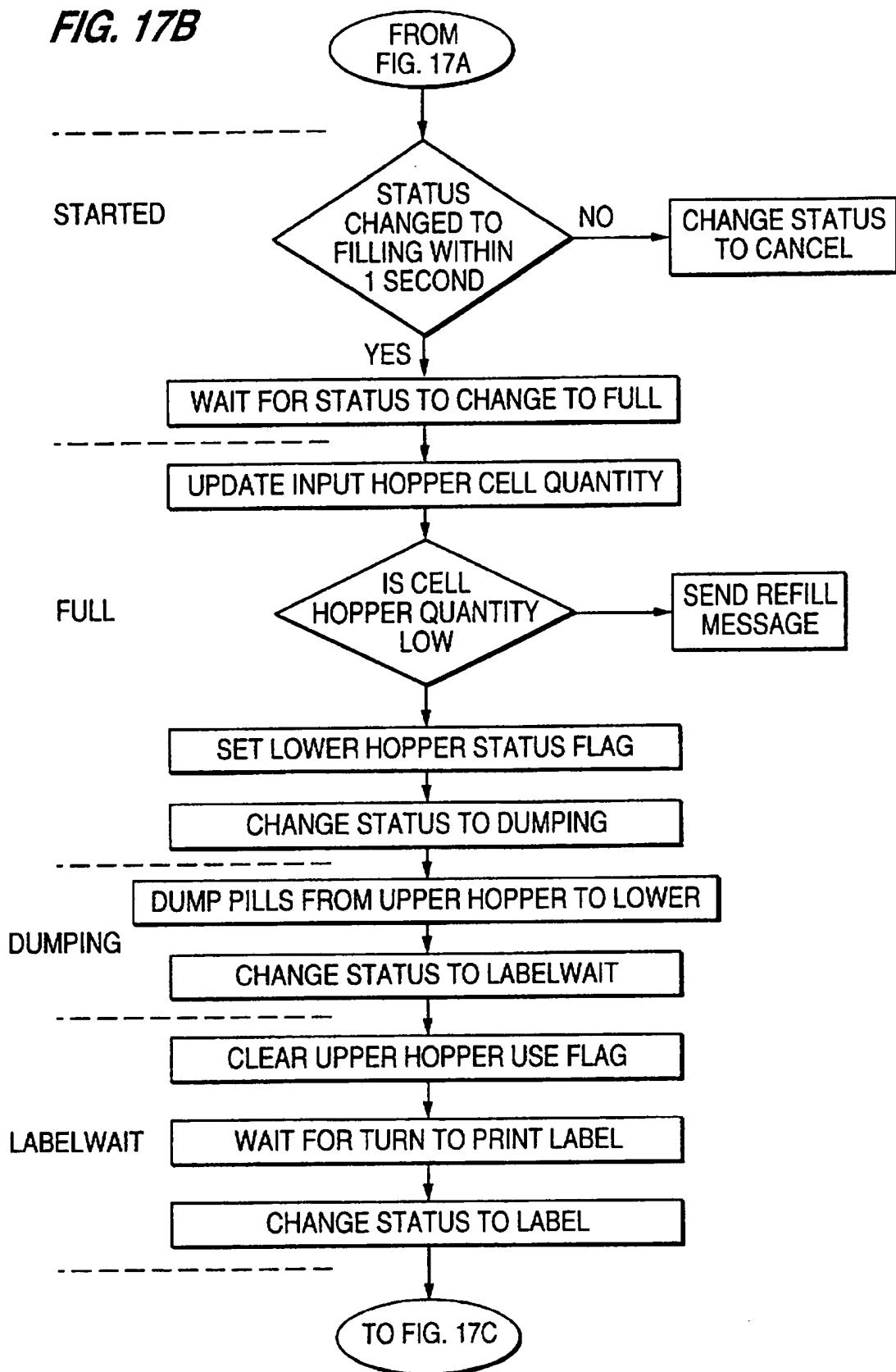
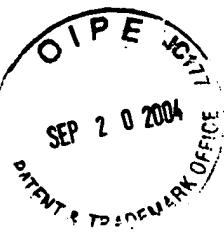
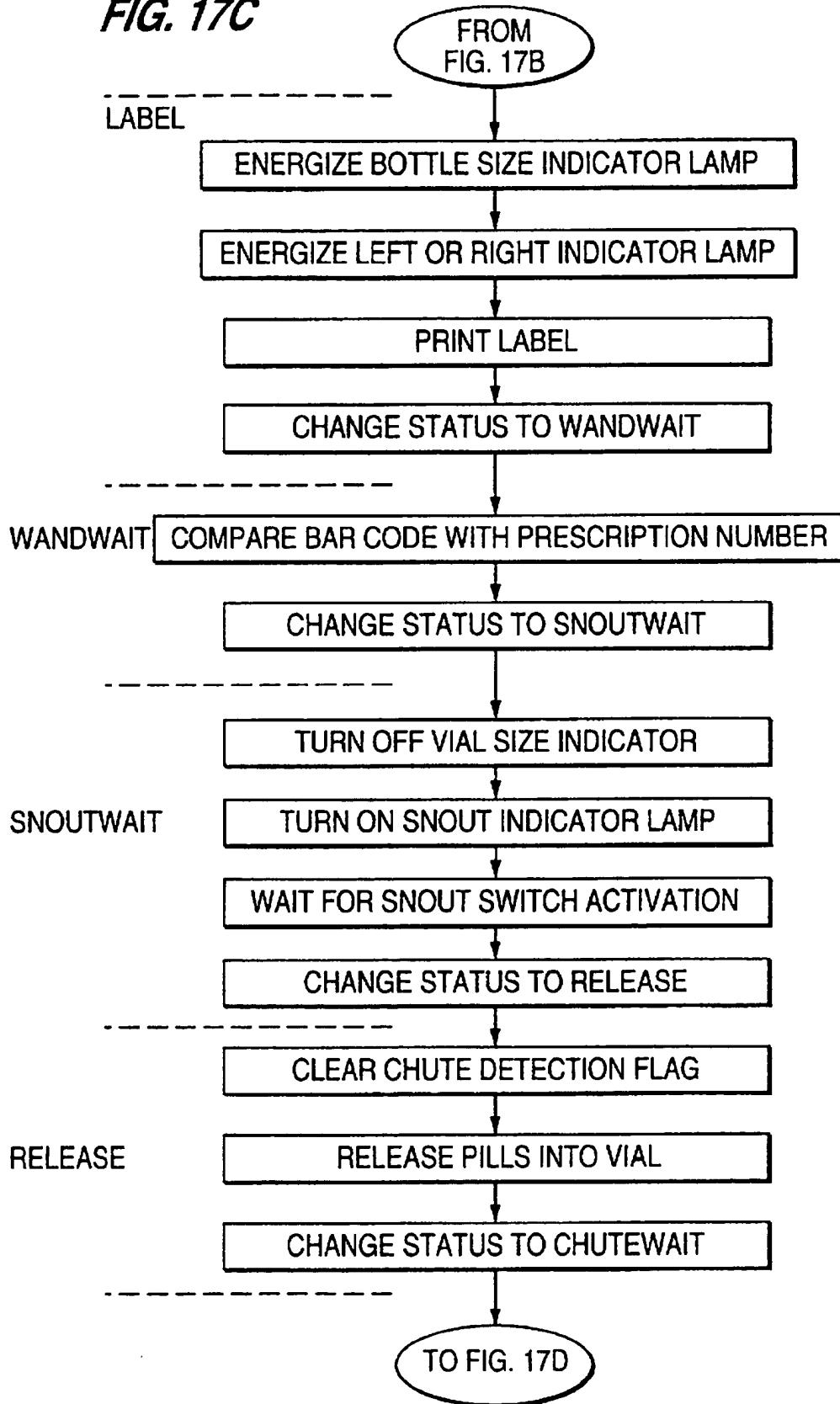
FIG. 17B

FIG. 17C



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FIG. 17D

